

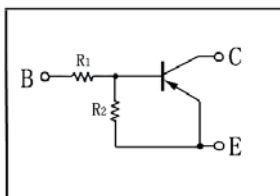
/ Descriptions

SOT-23 PNP

/ Features

/ Applications

/ Equivalent Circuit



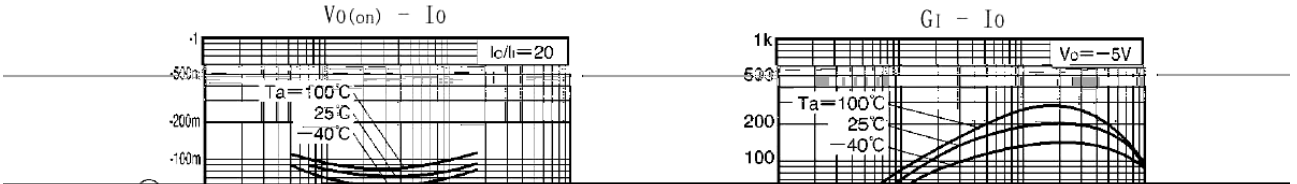
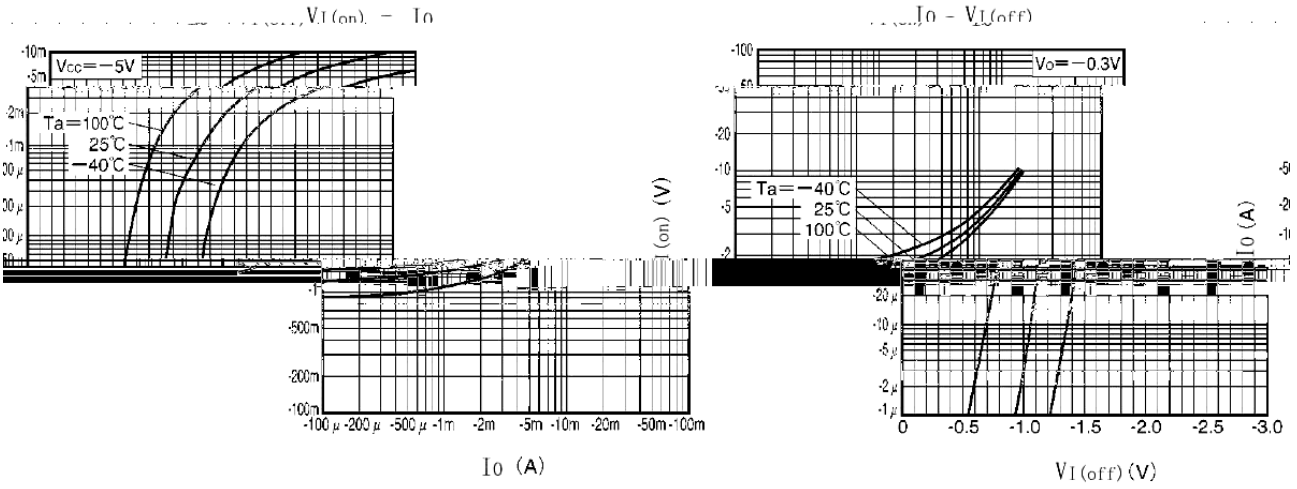
/ Pinning



/ h_{FE} Classifications & Marking

--	--

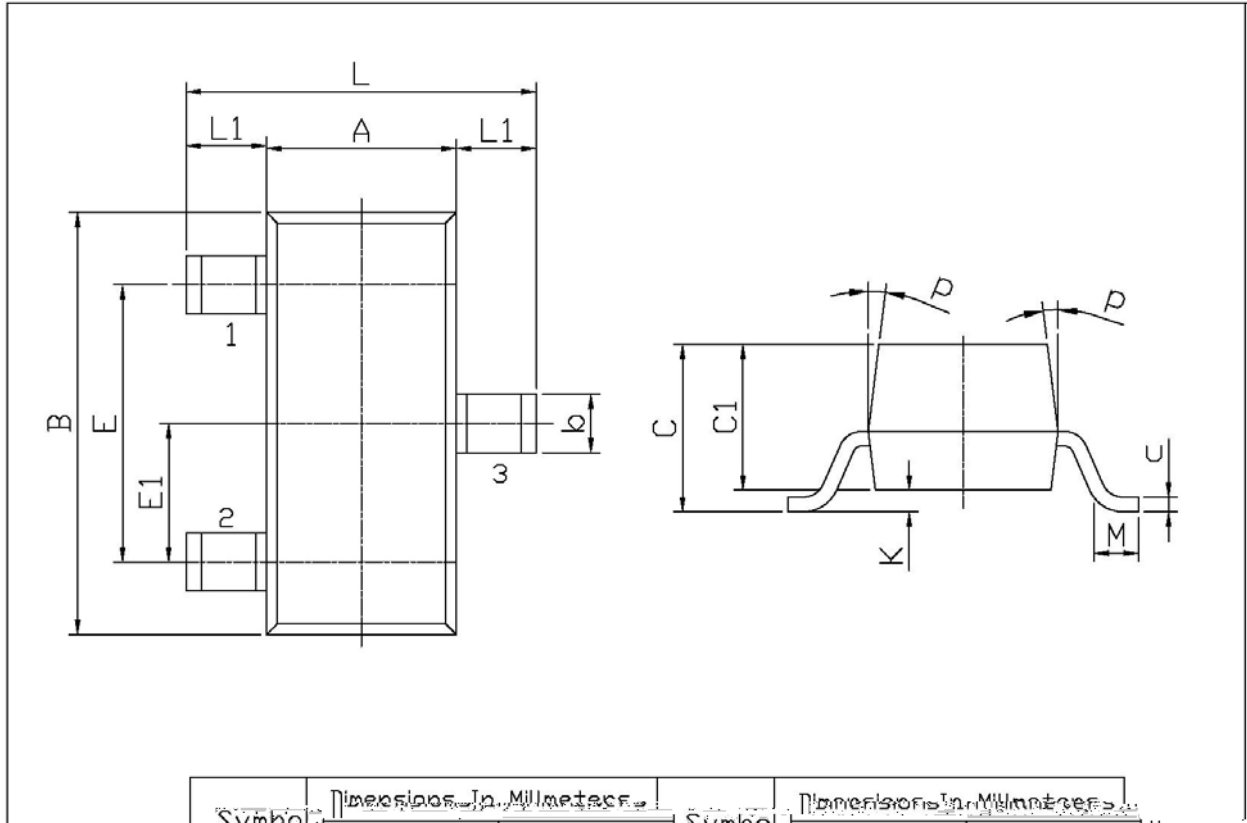
/ Electrical Characteristic Curve



/ Package Dimensions

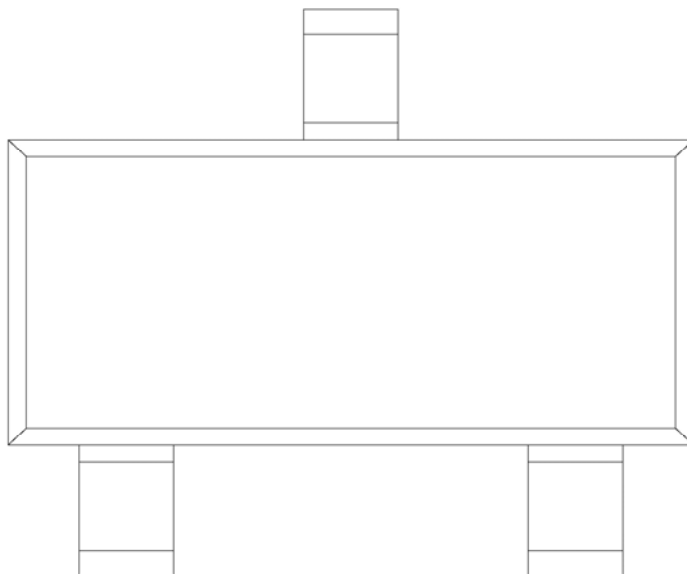
SOT-23

单位: mm



Dimension In Millimeter			Dimension In Millimeter		
Symbol	Min	Max	Symbol	Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	e	0.05	0.20
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	P	7°	
b	0.35	0.55			

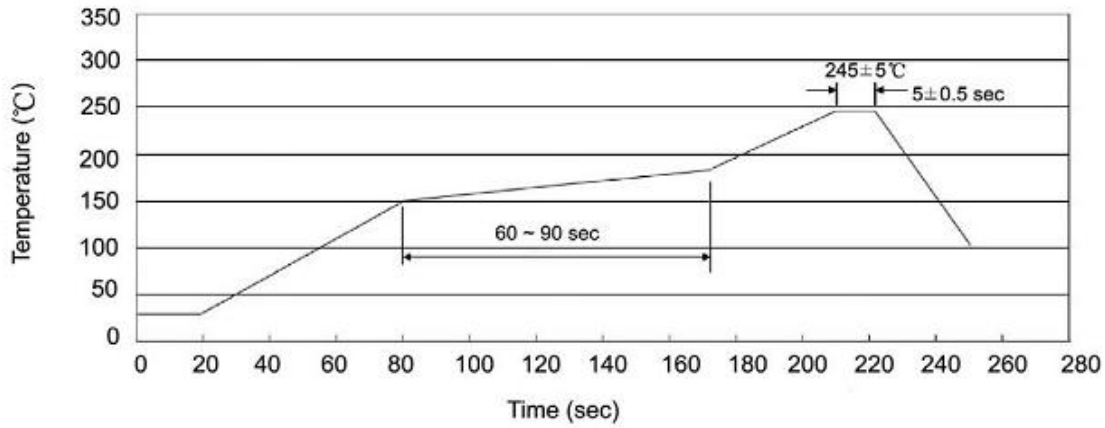
/ Marking Instructions



H

H

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± °C

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7 × 8	180×120×180	390×385×205

/ Notices